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Kind regards,

Team Nexperia



# **BSS84**

# P-channel enhancement mode vertical DMOS transistor Rev. 06 — 16 December 2008 Product data

Product data sheet

## **Product profile**

## 1.1 General description

P-channel enhancement mode vertical Diffusion Metal-Oxide Semiconductor (DMOS) transistor in a small Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number 11	Package	
	NXP	JEDEC
BSS84	SOT23	TO-236AB
BSS84/DG		

<sup>[1] /</sup>DG: halogen-free

## 1.2 Features

Low threshold voltage

High-speed switching

Direct interface to CMOS and Transistor-Transistor Logic (TTL)

No secondary breakdown

## 1.3 Applications

■ Line current interrupter in telephone sets ■ Relay, high-speed and line transformer drivers

## 1.4 Quick reference data

 $V_{DS} \le -50 \text{ V}$ 

 $\blacksquare$  R<sub>DSon</sub>  $\leq$  10  $\Omega$ 

■  $I_D \le -130 \text{ mA}$ 

P<sub>tot</sub> ≤ 250 mW



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001aaa025

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#### **Pinning information** 2.

Table 2. **Pinning** Pin **Symbol** Simplified outline **Graphic symbol** Description 1 G gate 2 S source 3 D drain SOT23 (TO-236AB)

#### **Ordering information** 3.

Ordering information Table 3.

Type number[1]				
	Name	Description	Version	
BSS84	TO-236AB	plastic surface-mounted package; 3 leads	SOT23	
BSS84/DG				

<sup>[1] /</sup>DG: halogen-free

# **Marking**

Table 4. **Marking codes** 

Type number[1]	Marking code[2]
BSS84	13*
BSS84/DG	ZV*

<sup>[1] /</sup>DG: halogen-free

[2] \* = -: made in Hong Kong

\* = p: made in Hong Kong

\* = t: made in Malaysia

\* = W: made in China

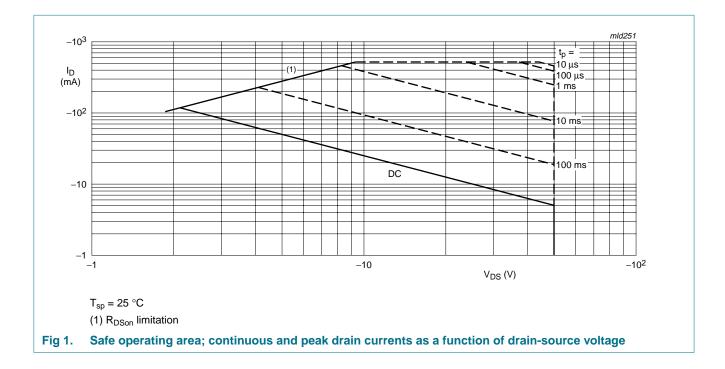
#### P-channel enhancement mode vertical DMOS transistor

# Limiting values

Table 5. **Limiting values** In accordance with the Absolute Maximum Rating System (IEC 60134).

		<b>0</b> , (			
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{\text{DS}}$	drain-source voltage	25 °C $\leq$ T $_{j}$ $\leq$ 150 °C	-	-50	V
$V_{GS}$	gate-source voltage		-	±20	V
I <sub>D</sub> drain current	$T_{sp} = 25 ^{\circ}\text{C}; V_{GS} = -10 \text{V};$ see Figure 1	-	-130	mA	
		T <sub>sp</sub> = 100 °C; V <sub>GS</sub> = -10 V	-	<del>-</del> 75	mA
I <sub>DM</sub>	peak drain current	$T_{sp}$ = 25 °C; $t_p \le 10 \mu s$ ; see <u>Figure 1</u>	-	-520	mA
P <sub>tot</sub>	total power dissipation	T <sub>sp</sub> = 25 °C; see <u>Figure 2</u>	[1] -	250	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C

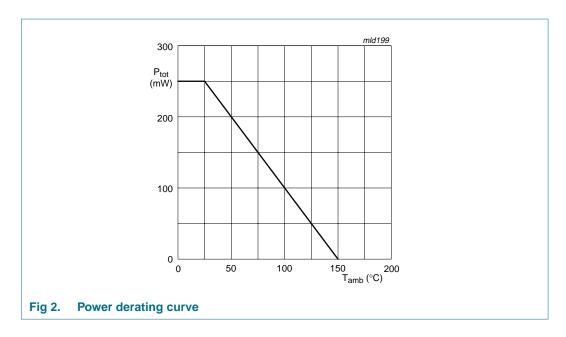
<sup>[1]</sup> Device mounted on a Printed-Circuit Board (PCB).



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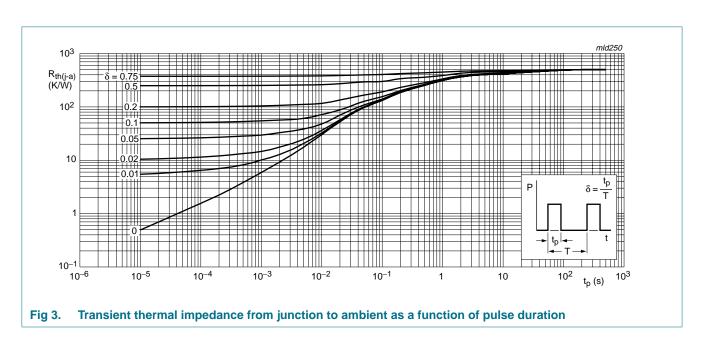


#### 6. Thermal characteristics

Table 6. **Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	see Figure 3	[1] _	-	500	K/W

[1] Mounted on a PCB, vertical in still air.



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#### P-channel enhancement mode vertical DMOS transistor

#### **7**. **Characteristics**

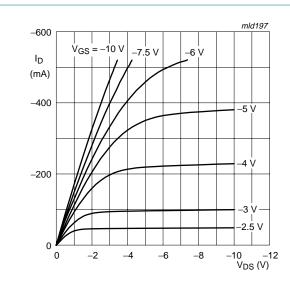
Table 7. Characteristics

 $T_j = 25 \,^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = -10 \ \mu A; \ V_{GS} = 0 \ V$	-50	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = -1$ mA; $V_{DS} = V_{GS}$ ; see Figure 8				
		T <sub>j</sub> = 25 °C	-0.8	-	-2	V
		T <sub>j</sub> = −55 °C	-	-	-1.8	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = -40 \text{ V}; V_{GS} = 0 \text{ V}$				
		T <sub>j</sub> = 25 °C	-	-	-100	nA
		$V_{DS} = -50 \text{ V}; V_{GS} = 0 \text{ V}$				
		T <sub>j</sub> = 25 °C	-	-	-10	μΑ
		T <sub>j</sub> = 125 °C	-	-	-60	μΑ
I <sub>GSS</sub>	gate leakage current	$V_{GS} = +20 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	100	nA
		$V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS} = -10 \text{ V};$ $I_D = -130 \text{ mA};$ see Figure 5 and 7	-	6	10	Ω
Dynamic o	characteristics					
Y <sub>fs</sub>	transfer admittance	$V_{DS} = -25 \text{ V};$ $I_D = -130 \text{ mA}$	50	-	-	mS
C <sub>iss</sub>	input capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = -25 \text{ V};$	-	25	45	pF
C <sub>oss</sub>	output capacitance	f = 1 MHz; see Figure 9	-	15	25	pF
C <sub>rss</sub>	reverse transfer capacitance		-	3.5	12	pF
t <sub>on</sub>	turn-on time	$V_{DS} = -40 \text{ V}; V_{GS} = 0 \text{ V}$ to -10 V; $I_{D} = -200 \text{ mA};$ see Figure 10 and 11	-	3	-	ns
t <sub>off</sub>	turn-off time	$V_{DS} = -40 \text{ V};$ $V_{GS} = -10 \text{ V to 0 V};$ $I_{D} = -200 \text{ mA};$ $SEE = \frac{\text{Figure 10}}{\text{Incomplete}} \text{ and } \frac{11}{\text{Incomplete}}$	-	7	-	ns

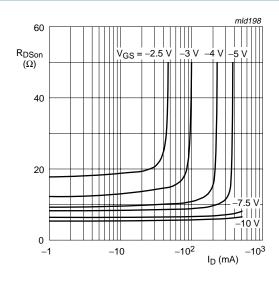
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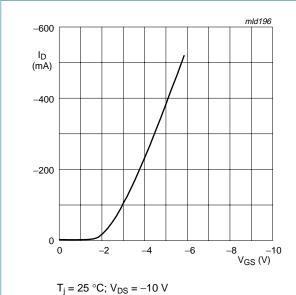
T<sub>i</sub> = 25 °C

Output characteristics: drain current as a Fig 4. function of drain-source voltage; typical values

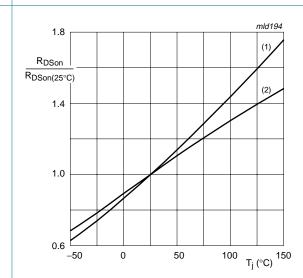


T<sub>i</sub> = 25 °C

Fig 5. Drain-source on-state resistance as a function of drain current; typical values



Transfer characteristics: drain current as a Fig 6. function of gate-source voltage; typical values



(1) 
$$I_D = -130$$
 mA;  $V_{GS} = -10$  V

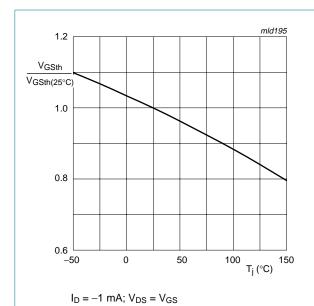
(2) 
$$I_D = -20 \text{ mA}$$
;  $V_{GS} = -2.4 \text{ V}$ 

Normalized drain-source on-state resistance Fig 7. factor as a function of junction temperature

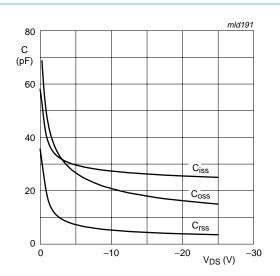
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Gate-source threshold voltage as a function of Fig 8. junction temperature



 $V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$ 

Input, output and reverse transfer Fig 9. capacitances as a function of drain-source voltage; typical values

#### 8. **Test information**

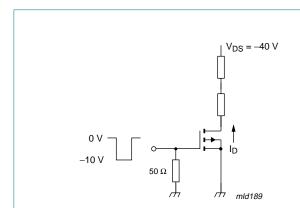
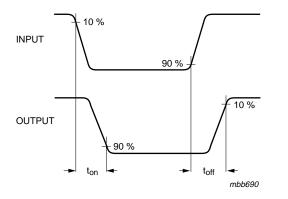


Fig 10. Switching time test circuit



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Fig 11. Input and output waveforms

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## Package outline

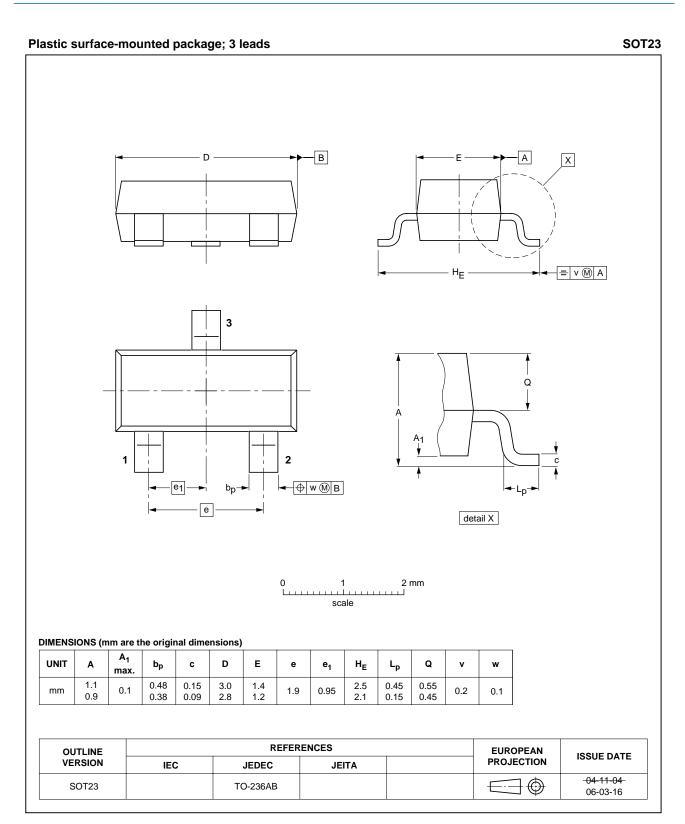


Fig 12. Package outline SOT23 (TO-236AB)

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### P-channel enhancement mode vertical DMOS transistor

# 10. Revision history

#### Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BSS84_6	20081216	Product data sheet	-	BSS84_5
Modifications:	• Table 5 "Lim	niting values": P <sub>tot</sub> figure refere	nce updated	
BSS84_5	20081209	Product data sheet	-	BSS84_4
BSS84_4	20070717	Product data sheet	-	BSS84_3
BSS84_3	20030804	Product specification	-	BSS84_2
BSS84_2	19970618	Product specification	-	BSS84_1
BSS84_1	19950407	Product specification	-	-

#### P-channel enhancement mode vertical DMOS transistor

## 11. Legal information

#### 11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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